

3.2x2.4mm SMD CHIP LED LAMP

# **Features**

• Ideal for indication light on hand held products

• Long life and robust package

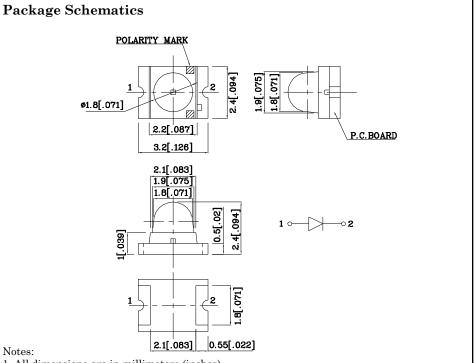
 $\bullet$  Standard Package: 1,500pcs/ Reel

 $\bullet$  MSL (Moisture Sensitivity Level): 3

• RoHS compliant







- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.1 (0.004")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T <sub>A</sub> =25°C)	MYK (AlGaInP)	Unit		
Reverse Voltage	$V_{R}$	5	V	
Forward Current	$I_{\mathrm{F}}$	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	$i_{\mathrm{FS}}$	175	mA	
Power Dissipation	$P_{D}$	75	mW	
Operating Temperature	$T_{A}$	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85		

Operating Characteristics ( $T_A$ =25°C)	MYK (AlGaInP)	Unit		
Forward Voltage (Typ.) ( $I_F$ =20mA)	$V_{\mathrm{F}}$	2	V	
Forward Voltage (Max.) ( $I_F$ =20mA)	$V_{\mathrm{F}}$	2.5	V	
Reverse Current (Max.) $(V_R=5V)$	$I_R$	10	uA	
Wavelength of Peak Emission CIE127-2007* (Typ.) (I <sub>F</sub> =20mA)	λΡ	590*	nm	
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I <sub>F</sub> =20mA)	λD	590*	nm	
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	$\triangle \lambda$	20	nm	
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	20	рF	

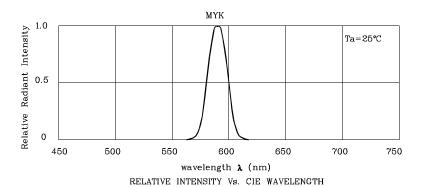
Part Number	Emitting Color	Emitting Material	Lens-color	CIE127-2007* (I <sub>F</sub> =20mA) med		wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
				min.	typ.		
ZMYK78W	Yellow	AlGaInP	Water Clear	1000*	1295*	590*	20°

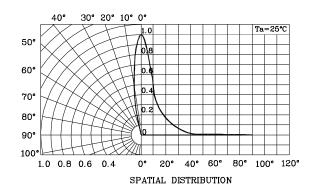
<sup>\*</sup>Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

Feb 18,2014 SDSA1646 V4-Z Layout: Maggie L.

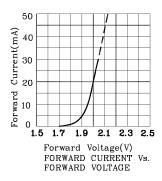


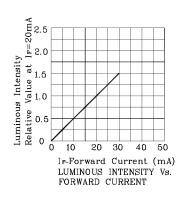


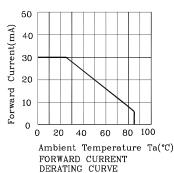


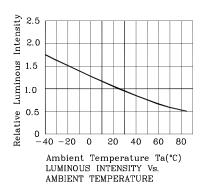


# **❖** MYK



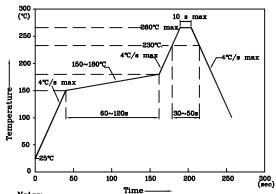






# LED is recommended for reflow soldering and soldering profile is shown below.

# Reflow Soldering Profile for SMD Products (Pb-Free Components)

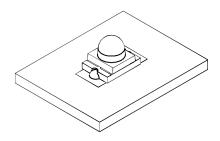


- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions

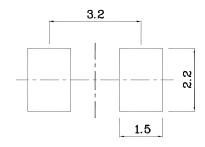


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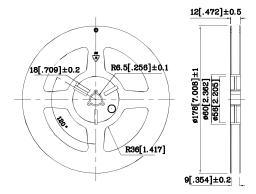
# ❖ The device has a single mounting surface. The device must be mounted according to the specifications.



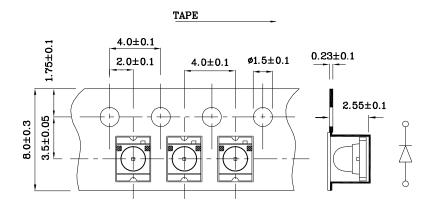
# ❖ Recommended Soldering Pattern (Units: mm; Tolerance: $\pm 0.1$ )



# **❖** Reel Dimension



# **❖** Tape Specification (Units:mm)



#### Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

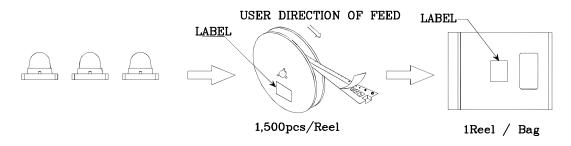
- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

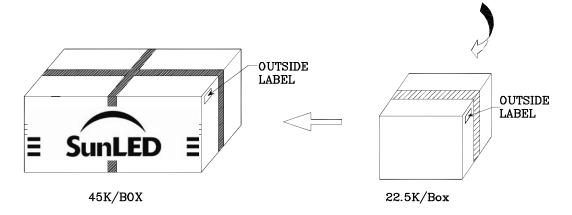
Note: Accuracy may depend on the sorting parameters.

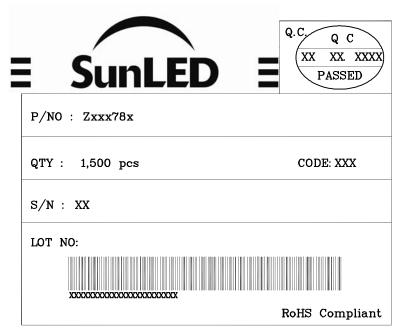




### PACKING & LABEL SPECIFICATIONS







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- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
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Feb 18,2014